



# **KEYFLEX BT 1033D**

Injection Molding, TPC-ET

#### Description

General Purpose, Low Modulus

#### **Application**

Auto Interior, Soft Touch Grips, Overmolding Parts, etc.

Properties	<b>Test Condition</b>	Test Method	Unit	Typical Value
Physical				
Specific Gravity		ASTM D792	-	1.09
Molding Shrinkage (Flow), 3.2mm		ASTM D955	%	0.4~0.8
Melt Flow Rate	230°C/2.16kg	ASTM D1238	g/10min	25
Water Absorption	23℃, 24hrs	ASTM D570	%	0.7
Mechanical				
Tensile Strength, 2mm		ASTM D638		
@ Yield	50mm/min		kg/cm <sup>2</sup>	
@ Break	50mm/min		kg/cm <sup>2</sup>	240
Tensile Elongation, 2mm		ASTM D638	• •	
@ Yield	50mm/min		%	
@ Break	50mm/min		%	800
Flexural Strength, 6.4mm	15mm/min	ASTM D790	kg/cm <sup>2</sup>	
Flexural Modulus, 6.4mm	15mm/min	ASTM D790	kg/cm <sup>2</sup>	
Tear Strength @ Break	50mm/min	ASTM D624	kg/cm	
IZOD Impact Strength, 6.4mm		ASTM D256		
(Notched)	<b>23</b> ℃		kg-cm/cm	No break
	-40℃		kg-cm/cm	No break
Shore Hardness	Shore D	ASTM D2240	-	31
Shore Hardness	Shore A	ASTM D2240	-	85
Thermal				
Melt Temperature @ Peak		ASTM D3418	${\mathbb C}$	185
Heat Deflection Temperature, 6.4mm		ASTM D648		
(Unannealed)	4.6kg		${\mathbb C}$	
Electrical				
Comparative Tracking Index(CTI)	Solution A	IEC 60112	Volts	600
Surface Resistivity		IEC 60093	Ohm	
Volume Resistivity	<b>23</b> ℃	ASTM D257	Ohm∙m	
Dielectric Strength, 1mm	<b>23</b> ℃	ASTM D149	kV/mm	
Dielectric Constant (10 <sup>6</sup> Hz)	<b>23</b> ℃	ASTM D150	sec	

Note) Typical values are only for material selection purpose, and variation within normal tolerances are for various colors.

Updated: 25-Jun-14

Values given should not be interpreted as specification and not be used for part or tool design.

All properties, except melt flow rate are measured on injection molulded specimens and after 48 hours storage at 23 °C, 50% relative humidty.

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## Processing Guide (Injection Molding)

Processing Parameters		Unit	Value
Drying Temperature		${\mathbb C}$	80 ~ 90
Drying Time		hrs	3 ~ 4
Maximum Moisture Content		%	0.01
Melt Temperature		$^{\circ}$	185 ~ 225
	Rear	$^{\circ}$	185 ~ 205
Cylinder Temperature	Middle	${\mathbb C}$	195 ~ 215
	Front	${\mathbb C}$	200 ~ 220
Nozzle Temperature		$^{\circ}$	200 ~ 220
Mold Temperature		$^{\circ}$	10 ~ 35
Back Pressure		kg/cm <sup>2</sup>	
Screw Speed		rpm	

Note) Back Pressure & Screw Speed are only mentioned as general guidelines.

#### *Processing Guide (Extrusion Molding)*

Processing Parameters		Unit	Value
Drying Temperature		${\mathbb C}$	80 ~ 90
Drying Time		hrs	3 ~ 4
Maximum Moisture Content		%	0.01
Melt Temperature		$^{\circ}$	185 ~ 225
Barrel Temperature	Zone 1	$^{\circ}$	180 ~ 200
	Zone 2	${\mathbb C}$	190 ~ 210
	Zone 3	${\mathbb C}$	190 ~ 210
	Zone 4	${\mathbb C}$	190 ~ 210
Adapter Temperature		$^{\circ}$	190 ~ 210
Die Temperature		$^{\circ}$	190 ~ 210

Note) Recommend initial lower temperatures settings to avoid material degradation/hang-up in die & purge material from extruder prior to shutdown.

Updated: 25-Jun-14

These may not apply or need adjustment in specific situations such as low shot sizes, thin wall molding and gas-assist molding.